

### PRODUCT/PROCESS CHANGE NOTIFICATION Generic Copy

### 06-AUG-2001

### SUBJECT: ON Semiconductor Product/Process Change Notification #11621

TITLE: Qualify Additional Subcontractor Site Of SMA And SMB Rectifiers

EFFECTIVE DATE: 05-Oct-2001

AFFECTED CHANGE CATEGORY: Subcontractor Assembly/Fab/Test Site

### **AFFECTED PRODUCT DIVISION: Bipolar Discretes Products**

### ADDITIONAL RELIABILITY DATA: Available

Contact your local ON Semiconductor Sales Office or Carolyn Antillon <RM8160@onsemi.com >

SAMPLES: Contact your local ON Semiconductor Sales Office or Mike Schager <RMF150@onsemi.com>

### FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:

Contact Sales Office or Chris Holly <RV1140@onsemi.com>

### **DISCLAIMER:**

Initial Product/Process Change Notification (IPCN) - First Notification distributed to customers. Distributed at least 120 days from the effective date of the change.

Final Product/Process Change Notification (FPCN) - Final Notification completing the notification process. Distributed at least 60 days from the effective date of the change. ON Semiconductor will consider this change approved unless specific conditions of acceptance are provided in writing within 30 days of receipt of this notice. To do so, contact your local ON Semiconductor Sales Office.

### **DESCRIPTION AND PURPOSE:**

ON Semiconductor currently produces some SMA and SMB General Purpose Rectifiers and Schottky Rectifiers at a subcontractor. In order to provide additional capacity, ON Semiconductor is qualifying our subcontractor's other facility in Seefull, China, where a similar production line already exists. In order to expedite this additional capacity to service our customers, we will start shipping product from the new site after 60 days from the PCN release date.

(Per AEC-Q101 guidelines):				
Test	Conditions			
HTRB	Vr=800V, Ta=150degC, 1000 hrs.			
Temp Cycle	Air to Air, -55 to +150C, 1000 cycles			
Autoclave	Ta=121C, RH= 100%, PSIg=15, 96 hrs.			
H3TRB	Vr=800V, Ta=85C, RH= 85%, 1000 hrs.			
IOL	Ta=25C, If = $0.8A$ , 2 minutes on/off, 15000 cycles			
D.P.A.	Post H3TRB and Temp Cycle			
Physical Dimension	Per Case Outline Drawing			
Res. To Solder Heat	270 C, Td=10s			

### **QUALIFICATION PLAN:**

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# **RELIABILITY DATA SUMMARY:** Reliability Test Results:

Reliability Test Results: Device: MRA4007T3 (Highest voltage surface mount device)

Test Desc.	Interval	Control	Test Lot A	Test Lot B	Test Lot C
HTRB	1000 hrs	0/80	0/80	0/80	0/80
Temp Cycle	1000 cyc	0/80	0/79	0/80	0/80
Autoclave	96 hrs	0/80	0/80	0/80	0/80
H3TRB	1000 hrs	0/80	0/80	0/80	0/80
IOL	15000 cyc	0/80	0/80	0/80	0/80
D. P. A.	-	Pass	Pass	Pass	Pass
Physical Dime	nsion -	Pass	Pass	Pass	Pass
Res. To Solder	Heat -	Pass	Pass	Pass	Pass

# **ELECTRICAL CHARACTERISTIC SUMMARY:**

	CHARACTERISTIC SUN	IMARY:					
Device - MRA4007T3							
Test Temperature							
Forward Voltage	(volts) @ If=0.5A						
	CONTROL (TAIWAN)	TEST GROUP (SEEFULL)					
		Lot 1 Lot 2 Lot3					
MAX LIMIT	0.950	0.950 0.950 0.950					
MIN	0.892	0.892 0.892 0.892					
MAX	0.907	0.912 0.916 0.919					
AVERAGE	0.899	0.896 0.899 0.898					
STD DEV	0.005	0.006 0.007 0.008					
СРК	3.4	3.0 2.4 2.2					
Forward Voltage	(volts) @ If=1.0A						
U	CONTROL (TAIWAN)	TEST GROUP (SEEFULL)					
	× /	Lot 1 Lot 2 Lot3					
MAX LIMIT	1.100	1.100 1.100 1.100					
MIN	0.946	0.946 0.946 0.941					
MAX	0.970	0.980 0.980 0.985					
AVERAGE	0.957	0.953 0.957 0.956					
STD DEV	0.008	0.010 0.010 0.012					
СРК	6.0	4.9 4.8 4.0					
Reverse Leakage (nanoamps) @ Vr=400V							
8-	CONTROL (TAIWAN)	TEST GROUP (SEEFULL)					
		Lot 1 Lot 2 Lot3					
MAX LIMIT	10000	10000 10000 10000					
MIN	052	71 62 88					
MAX	231	267 162 399					
AVERAGE	107	156 102 123					
STD DEV	54	68 23 56					
СРК	61.1	48.3 143.5 58.8					
Reverse Leakage	(nanoamps) @ Vr=1000V						
Tte verse Dealinge	CONTROL (TAIWAN)	TEST GROUP (SEEFULL)					
		Lot 1 Lot 2 Lot3					
MAX LIMIT	10000	10000 10000 10000					
MIN	145	188 148 246					
MAX	541	632 541 495					
AVERAGE	290	460 284 338					
STD DEV	125	160 79 65					
CPK	25.9	19.9 41.0 49.6					
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# CHANGED PART IDENTIFICATION:

Customers may receive effected SMA and SMB product manufactured from either Seefull or Taiwan starting with Date Code 0141 or later. The marking on the Seefull products will include PK.

### AFFECTED DEVICE LIST (WITHOUT SPECIALS)

PART MBRS120-1T3 MBRS140-1T3 MBRS140LT3 MBRS1540HT3 MRS1504T3